



**ASSEMBLY NOTES:**

Built on PMP10164 Rev\_A PWB

Disconnect C18, R19 and Q3 (emitter) from C10 and insert a 10 Ohm resistor in series (R100)

Ref. Des. > 99 have been added on the board

"DNP" = "Do Not Populate"

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Designed for: Public Release		Mod. Date: 23.06.2015	
Project Title: Universal input to 10.5V@1.8A Sync Flyback			
Sheet Title: Universal input to 10.5V@1.8A Sync Flyback			
Number: PMP10164	Rev: B	Assembly Variant: [No Variations]	Sheet: 1 of 1
SVN Rev: Version control disabled		File: PMP10164 Rev_B Schematic.SchDoc	Size: B
Drawn By: R. Scibilia		Contact: <a href="http://www.ti.com/support">http://www.ti.com/support</a>	
Engineer: R. Scibilia		© Texas Instruments, 2015	

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